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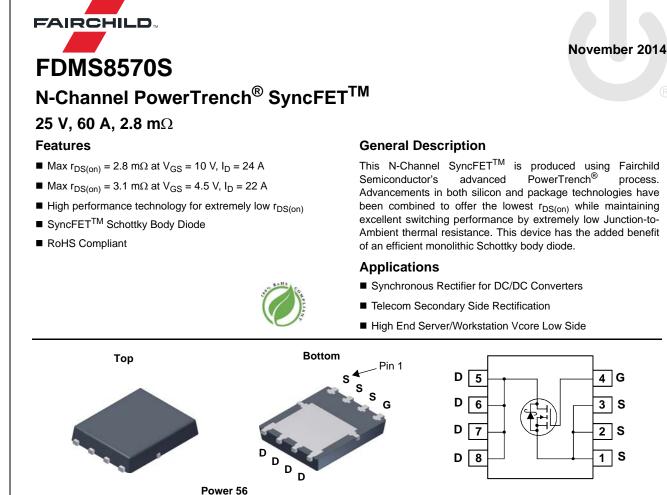


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			25	V	
V _{GS}	Gate to Source Voltage			12	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		60		
	-Continuous	T _A = 25 °C	(Note 1a)	24	Α	
	-Pulsed			100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	45	mJ	
P _D	Power Dissipation $T_{\rm C} = 25$			48	14/	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

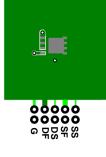
Thermal Characteristics

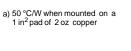
$R_{\theta JC}$	Thermal Resistance, Junction to Case	T _C = 25 °C	2.6	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a	a) 50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
10OD	FDMS8570S	Power 56	13"	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	25			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$, referenced to 25 °C		23		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			500	μΑ
I _{GSS}	Gate to Source Leakage Current	V_{GS} = +12 V/-8 V, V_{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	1.1	1.5	2.2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$, referenced to 25 °C		-3		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 24 A		2.1	2.8	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 22 \text{ A}$		2.4	3.1	mΩ
		V _{GS} = 10 V, I _D = 24 A, T _J = 125 °C		2.9	3.9	1
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 24 A$		215		S
	Characteristics			2025		~ [
C _{iss} C _{oss}	Input Capacitance Output Capacitance	– V _{DS} = 13 V, V _{GS} = 0 V,		2825 662		pF pF
C _{oss} C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		94		pF
R _g	Gate Resistance			0.8		Ω
				0.0		
	J Characteristics			11		ns
t _r	Rise Time	V _{DD} = 13 V, I _D = 24 A,		4		ns
t _{d(off)}	Turn-Off Delay Time	$V_{DD} = 13 \text{ V}, \text{ I}_{D} = 24 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		33		ns
•a(on) t _f	Fall Time			3		ns
Q _a	Total Gate Charge	V _{GS} = 0 V to 10 V		42		nC
Q _g	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 13 \text{ V},$		22		nC
Q _{gs}	Gate to Source Gate Charge	$I_D = 24 \text{ A}$		6.4		nC
Q _{gd}	Gate to Drain "Miller" Charge			4.4		nC
*	urce Diode Characteristics			1	I	L.
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.6	0.8	
		$V_{GS} = 0 V, I_S = 24 A$ (Note 2)		0.8	1.2	V
t _{rr}	Reverse Recovery Time			22		ns
Q _{rr}	Reverse Recovery Charge	$-I_F = 24 \text{ A}, \text{ di/dt} = 300 \text{ A/}\mu\text{s}$		19		nC







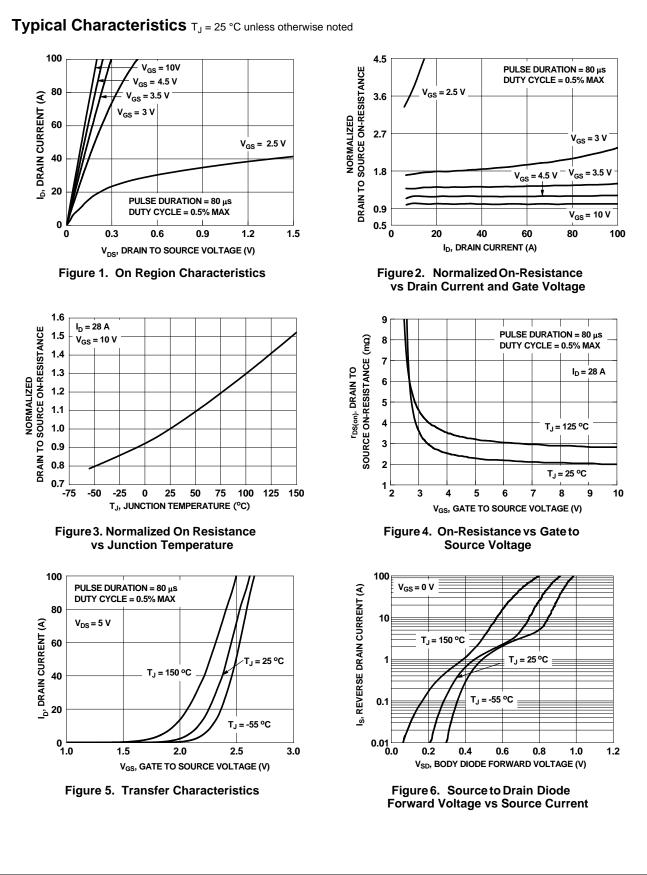
b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. E_{AS} of 45 mJ is based on starting T_J = 25 °C, L = 0.4 mH, I_{AS} = 15 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 23.8 A.

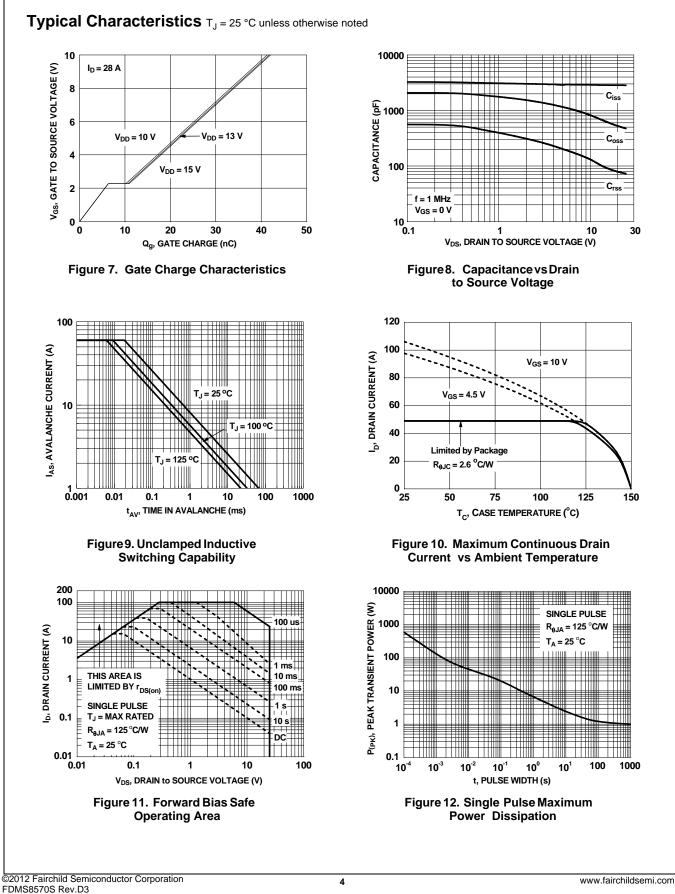
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FDMS8570S N-Channel PowerTrench[®] SyncFETTM

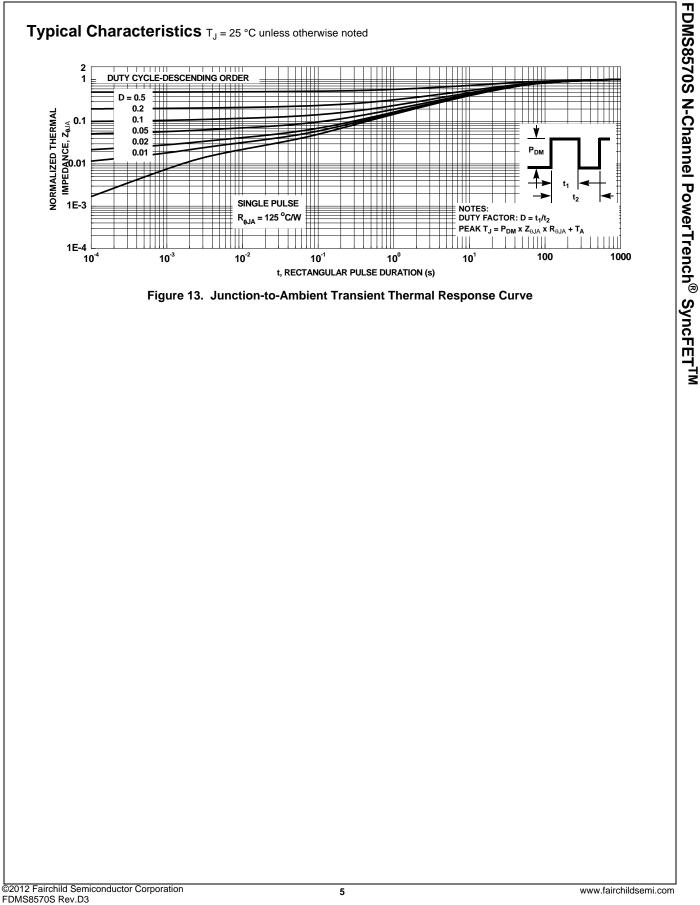


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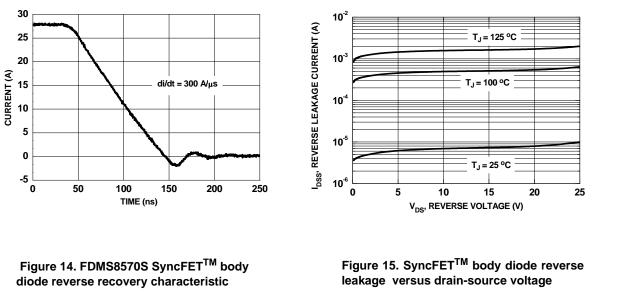
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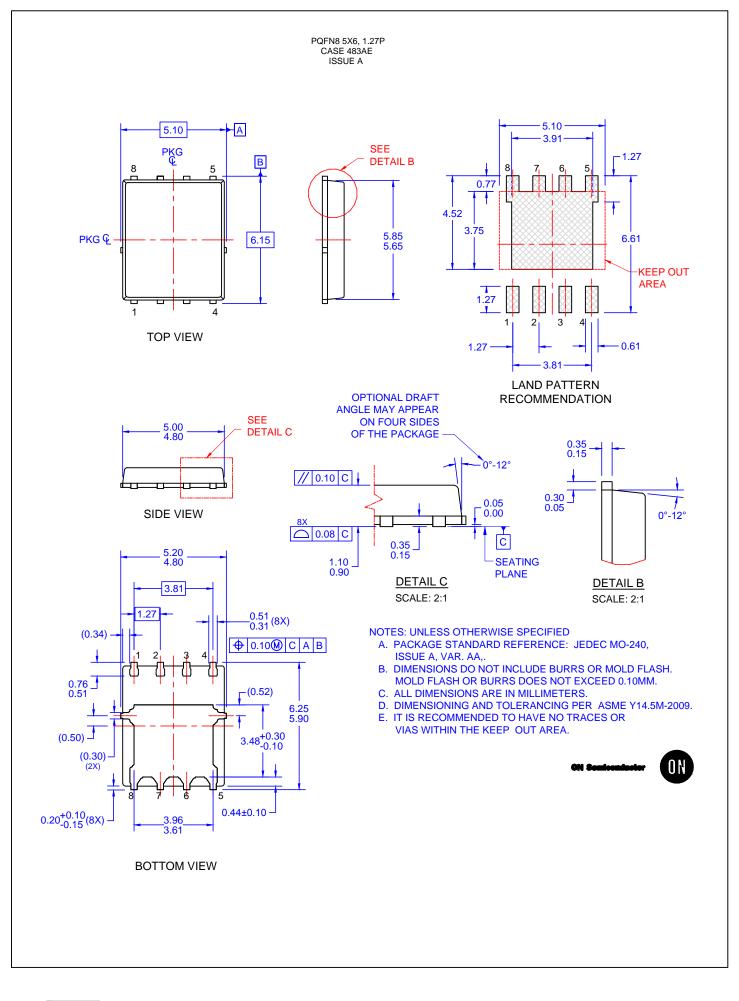
Typical Characteristics (continued)

SyncFET[™] Schottky body diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS8570S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.





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